05P1WPH111 Thin Films

Subject Code	05P1WPH111		
Subject Name	Thin Films		
Credits	3		Contact Hours: 03
Module No.	Subtitle of the Module	Topics	
1.	Vacuum (Artificial, Natural)Applicat ions	importance, Production of low pressure, Vacuum pumps(Principle, Parameters), Mechanical pumps, Vapour pumps, Ion pumps, Sorption pumps, Cryopumping, Gettering, Pumping by dilution, Measurement of pumping speed, thermal conductivity gauges (Pirani, thermocouple, Mc-leod Pirani, Penning), High vacuum Technology, criterion for selection of materials, Cleaning techniques, sealing techniques, Leak detection, rules for operating vacuum systems	
2.	Thin film	basics and introduction, nature, kinetic theory, Deposition technology thermal evaporation(resisitive heating, electron beam, flash sputtering (dc, RF,cathodic, gow discharge, magnetron, reactive, ion assisted, ion sources, ion etching), chemical vapour deposition (reaction types, boundaries and flow) (LPCVD, PECVD, LECVD, MOCVD), chemical bath deposition(electrodeposition, Anodic oxidation, electrolysis plating, deposition by chemical reaction, chemical displacement), Molecular beam epitaxy)	
3.	Kinetics	Homogeneous formation, Intro nucleation), Ef impurity, surfa defects, impuri	Diffusion coef, Arrhenius, Nucleation and Growth: nucleation, critical radius, nucleation rate, Film oduction, Trapping, Capillarity model (heterogeneous fects of super saturation, temperature, lattice strain, ace imperfections, Coalescence, incorporation of ties in films, Film formation, Growth modes, island nodels, columnar growth, Deposition parameters and film growth
4.	Substrate surface and thin film nucleation	thickness and characterization	ing, atomic view, film structure, morphololgy, film its control, structural characterization, chemical and defects and imperfections, Temperature of tabilisation of film, preparation of specimen
5.	Semiconducting Films	level (Doping, a Transport proper Activation ener carriers, carrier thermoelectric	alloying, surface states, recombination centres, traps), erties and basic parameters (conductivity, resistivity, rgy, band gap, hall coefficient, mobility of charge concentration, magneto resistance, Seebeck effect, power, size effect), Semiconductor surface and space netal semiconductor contact

6.	Experimental Techniques	film property measurements, film thickness (optical method-interfreometry, mechanical method), Structural Thin film analysis-diffraction Atomic scattering factor, kinetic theory of scattering, Electron diffraction techniques (HEED, LEED,) electron microscopy, SEM, TEM, FEM, EPMA, EIM, AES, XPES(ESCA),
		Mass spectroscopy

	Recommended Reading (Books/Journals/Reports/Websites etc.: Author(s), Title, Edition, Publisher, Year of Publication etc. in IEEE format)			
1.	Vacuum technology by A. Roth, Elsevier, 1990			
2.	Thin Film Fundamentals by A Goswami, New Age International 2005			
3.	Thin Films Phenomenon by K.L. Chopra, Krieger, 1985			
4.	Material Science of Thin Films, by Milton Ohring, Elsevier 2002			
5.	Handbook of Vacuum science and technology, Dorothy M. Hoffman, Academic Press (1997)			
6.	Physical Vapor Deposition of Thin Films, John E. Mahan, John Wiley & Sons (2000)			